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B/O FORM PTO-1595 (Rev. 4/00)

U.S. Department of Commerce Patent and Trademark Office



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To the Commissioner for Patents. Please record the attached original documents or copies thereof.

1. Name of Conveying Party(ies):

Kuo-Pin YANG

2. Name and Address of Receiving Party(ies):

Name: Advanced Semiconductor Engineering, Inc.

Street Address: No. 26, Jingsan Rd., Nantz Chiu

City, State, Zip: Kaohsiung, Taiwan 811, R.O.C.

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

Execution Date: April 27, 2006

☐ Additional name(s) and address(es) attached.

4. (A) Patent Application Number(s):

4. (B) Patent Number(s):

If this document is being filed together with a new application, the execution date of the application is: April 27, 2006

☐ Additional Numbers Attached.

Title: METHOD OF FABRICATING WAFER LEVEL PACKAGE

Attorney Docket No.: YANG3264/EM

5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:

Name:

Eugene Mar

23364

CUSTOMER NUMBER

Bacon & Thomas, PLLC
625 Slaters Lane Fourth Floor
Alexandria, VA 22314

Total Number of Applications and Patents Involved:

1

7. Total Fee:
(37 CFR 3.41)

\$40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit Account Number: 02-0200

9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Richard E. Fichter, 26,382

Name of Person Signing

Signature

May 3, 2006

Date

Total number of pages including cover sheet, attachments and document: 3

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PATENT
REEL: 017852 FRAME: 0275

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ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION
Page 2 of 2

ASSIGNOR:

Signature: Kuo-Pin Yang

Printed Name: Kuo-Pin Yang

Date: April 27, 2006

日月光編號 ASE1421 || 三達編號 US2229PA

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